onsemi

N-Channel Enhancement Mode Field Effect Transistor

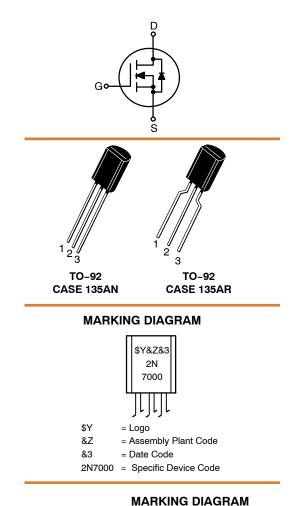
2N7000, 2N7002, NDS7002A

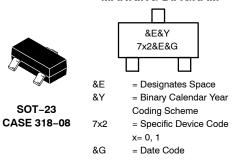
Description

These N-channel enhancement mode field effect transistors are produced using **onsemi's** proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while providing rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 400 mAdc and can deliver pulsed currents up to 2 A. These products are particularly suited for low-voltage, low-current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Features

- High Density Cell Design for Low R_{DS(on)}
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- High Saturation Current Capability
- This Device is Pb–Free and Halogen Free





ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

			Value			
Symbol	Parameter	2N7000	2N7002	NDS7002A	Unit	
V _{DSS}	Drain-to-Source Voltage		60	•	V	
V _{DGR}	Drain-Gate Voltage ($R_{GS} \le 1$ MW)		60		V	
V _{GSS}	Gate-Source Voltage - Continuous		±20			
	Gate-Source Voltage - Non Repetitive (tp < 50 ms)		±40			
Ι _D	Maximum Drain Current – Continuous	200	115	280	mA	
	Maximum Drain Current – Pulsed	500	800	1500		
PD	Maximum Power Dissipation Derated above 25°C	400	200	300	mW	
		3.2	1.6	2.4	mW/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55	-55 to 150 -65 to 150		°C	
ΤL	Maximum Lead Temperature for Soldering Purposes, 1/16-inch from Case for 10 s		300		°C	

ABSOLUTE MAXIMUM RATINGS Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

		Value			
Symbol	Parameter	2N7000	2N7002	NDS7002A	Unit
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	312.5	625	417	°C/W

ELECTRICAL CHARACTERISTICS

Values are at T_C = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Туре	Min.	Тур.	Max.	Unit
FF CHARA	CTERISTICS						-
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = 10 μ A	All	60	_	-	V
I _{DSS}	Zero Gate Voltage Drain	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	2N7000	-	-	1	μA
	Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$		-	_	1	mA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	2N7002	_	-	1	μA
		V_{DS} = 60 V, V_{GS} = 0 V, T_{C} = 125°C	NDS7002A	-	-	0.5	mA
I _{GSSF}	Gate – Body Leakage, Forward	V_{GS} = 15 V, V_{DS} = 0 V	2N7000	-	-	10	nA
		V_{GS} = 20 V, V_{DS} = 0 V	2N7002 NDS7002A	-	_	100]
I _{GSSR}	Gate – Body Leakage,	V_{GS} = -15 V, V_{DS} = 0 V	2N7000	-	10	nA	
	Reverse	V_{GS} = -20 V, V_{DS} = 0 V	2N7002 NDS7002A	-	-	-100	1

ON CHARACTERISTICS

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	2N7000	0.8	2.1	3	V
		$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2N7002 NDS7002A	1	2.1	2.5	

ELECTRICAL CHARACTERISTICS (continued) Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Туре	Min.	Тур.	Max.	Unit
ON CHARAC	TERISTICS						
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 500 mA	2N7000	_	1.2	5	Ω
	On-Resistance	V_{GS} = 10 V, I _D = 500 mA, T _C = 125°C		-	1.9	9	
		V_{GS} = 4.5 V, I _D = 75 mA		-	1.8	5.3	
		V_{GS} = 10 V, I _D = 500 mA	2N7002	-	1.2	7.5	1
		V_{GS} = 10 V, I _D = 500 mA, T _C = 100°C		-	1.7	13.5	
		V_{GS} = 5 V, I_D = 50 mA		-	1.7	7.5	1
		V_{GS} = 5 V, I_D = 50 mA, T_C = 100°C		-	2.4	13.5	-
		V_{GS} = 10 V, I _D = 500 mA	NDS7002A	-	1.2	2	
		V_{GS} = 10 V, I _D = 500 mA, T _C = 125°C		-	2	3.5	
		$V_{GS} = 5 \text{ V}, \text{ I}_{D} = 50 \text{ mA}$		-	1.7	3	
		V_{GS} = 5 V, I_D = 50 mA, T_C = 125°C		-	2.8	5	
V _{DS(on)}	Drain-Source On-Voltage	V _{GS} = 10 V, I _D = 500 mA	2N7000	-	0.6	2.5	V
		V_{GS} = 4.5 V, I _D = 75 mA		-	0.14	0.4	1
		V_{GS} = 10 V, I _D = 500 mA	2N7002	-	0.6	3.75	1
		$V_{GS} = 5.0 \text{ V}, \text{ I}_{D} = 50 \text{ mA}$		-	0.09	1.5	1
		V_{GS} = 10 V, I _D = 500 mA	NDS7002A	-	0.6	1	
		V_{GS} = 5.0 V, I _D = 50 mA		-	0.09	0.15	
I _{D(on)}	On-State Drain Current	V_{GS} = 4.5 V, V_{DS} = 10 V	2N7000	75	600	-	mA
		V_{GS} = 10 V, $V_{DS} \geq$ 2 $V_{DS(on)}$	2N7002	500	2700	-	
		V_{GS} = 10 V, $V_{DS} \geq$ 2 $V_{DS(on)}$	NDS7002A	500	2700	-	
9fs	Forward Transconductance	V_{DS} = 10 V, I_{D} = 200 mA	2N7000	100	320	-	mS
		$V_{DS} \geq 2 \ V_{DS(on)}, \ I_D = 200 \ mA$	2N7002	80	320	-	
		$V_{DS} \ge 2 V_{DS(on)}, I_D = 200 \text{ mA}$	NDS7002A	80	320	-	

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V,$	All	-	20	50	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	All	-	11	25	
C _{rss}	Reverse Transfer Capacitance		All	-	4	5	
t _{on}	Turn-On Time		2N7000	-	-	10	ns
			2N7002 NDS7002A	-	-	20	
t _{off}	Turn-Off Time		2N7000	_	-	10	ns
			2N7002 NDS7002A	_	_	20	

ELECTRICAL CHARACTERISTICS (continued)

Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Туре	Min.	Тур.	Max.	Unit

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ _S	Maximum Continuous Drain-S	ource Diode Forward Current	2N7002	-	-	115	mA
			NDS7002A	_	-	280	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	2N7002	-	-	0.8	Α	
			NDS7002A	-	-	1.5	
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 115 mA$ (Note 1)	2N7002	-	0.88	1.5	V
		V _{GS} = 0 V, I _S = 400 mA (Note 1)	NDS7002A	-	0.88	1.2	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse test: Pulse Width \leq 300 µs, Duty Cycel \leq 2 %



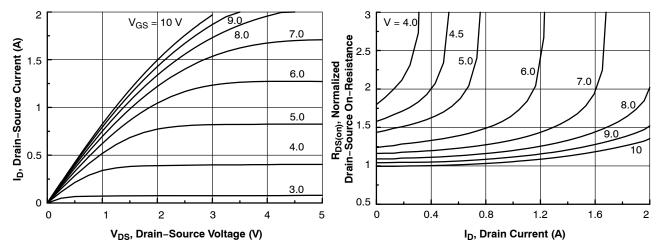
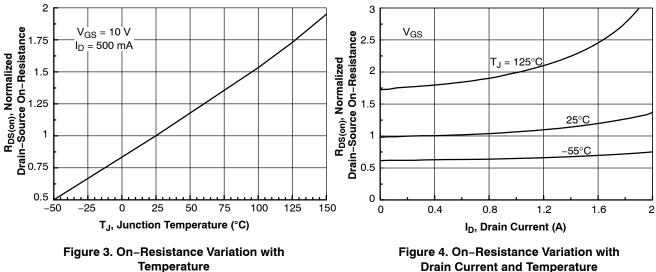


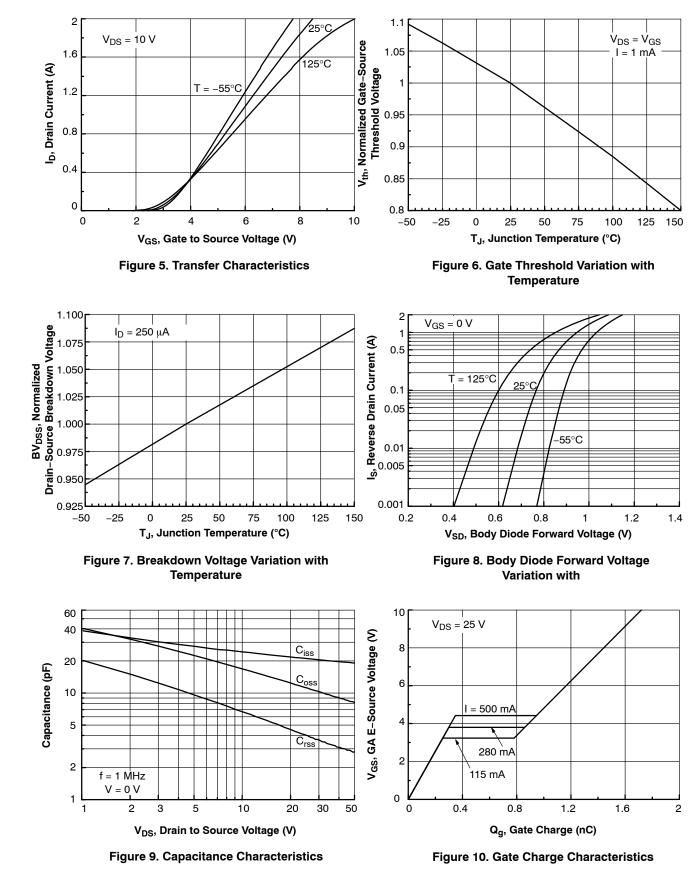


Figure 2. On-Resistance Variation with **Gate Voltage and Drain Current**



Drain Current and Temperature





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

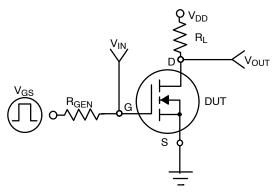


Figure 11. Switching Test Circuit

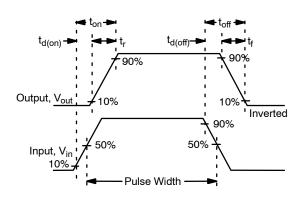


Figure 12. Switching Waveforms

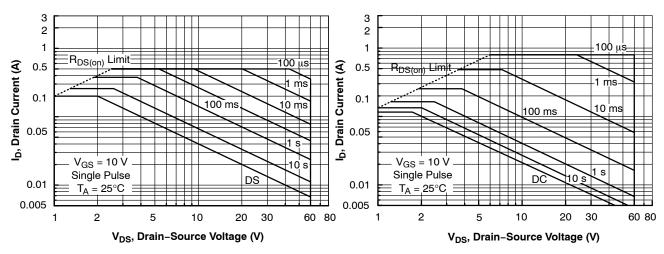




Figure 14. 2N7002 Maximum Safe Operating Area

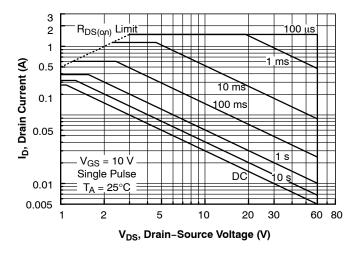


Figure 15. NDS7000A Maximum Safe Operating Area

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

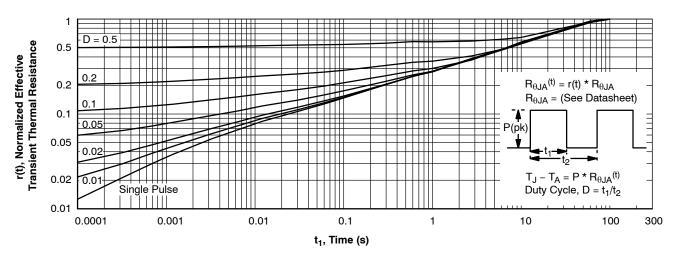


Figure 16. TO-92, 2N7000 Transient Thermal Response Curve

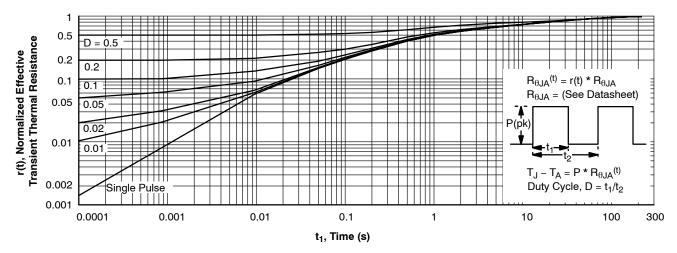


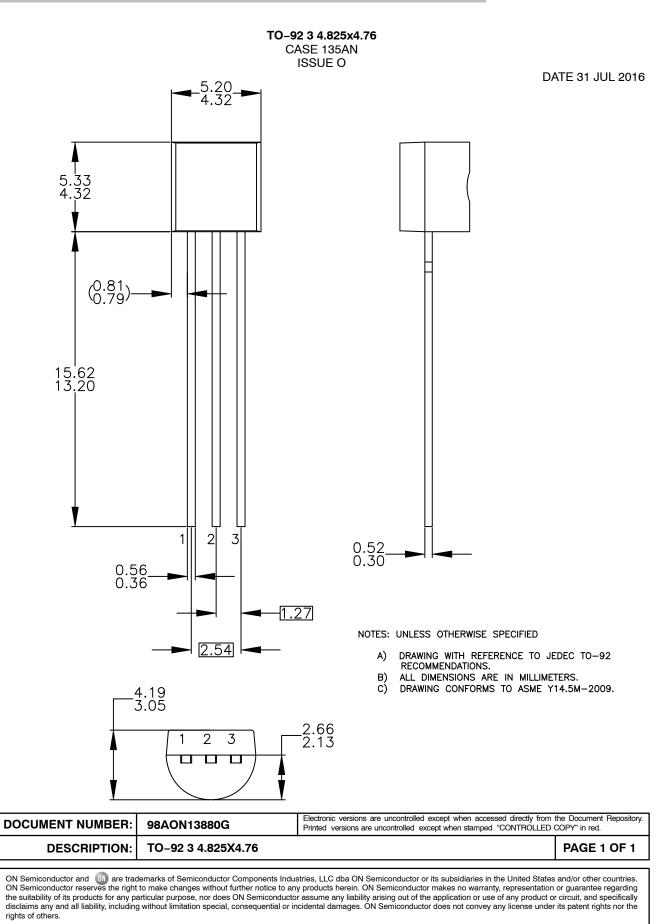
Figure 17. SOT-23, 2N7002 / NDS7002A Transient Thermal Response Curve

ORDERING INFORMATION

Part Number	Marking	Package	Packing Method †	Min Order Qty / Immediate Pack Qty
2N7000	2N7000	TO-92 3L	Bulk	10000 / 1000
2N7000-D74Z		(Pb-Free)	Ammo	2000 / 2000
2N7000-D75Z			Tape and Reel	2000 / 2000
2N7000-D26Z				2000 / 2000
2N7002	702	SOT-23 3L	Tape and Reel	3000 / 3000
NDS7002A	712	(Pb-Free)		3000 / 3000

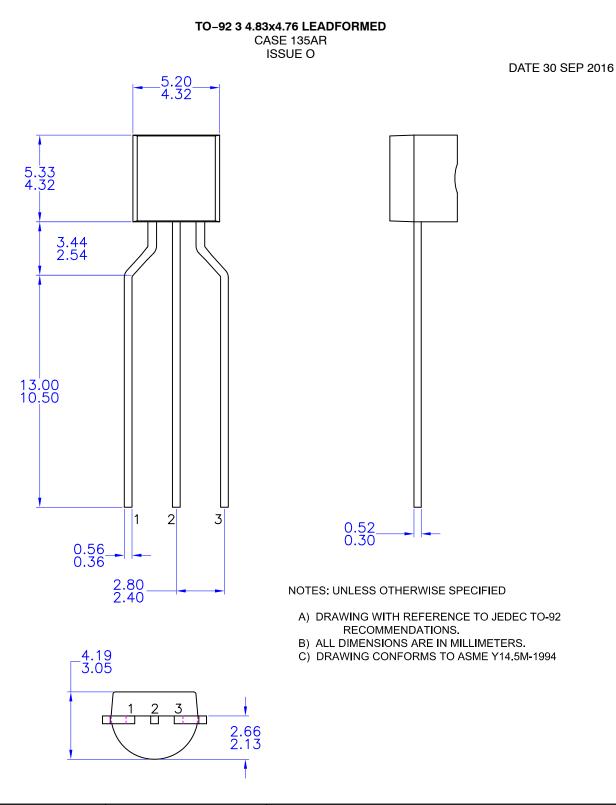
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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